

HSF

NOTES:

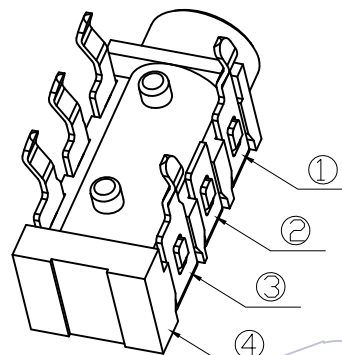
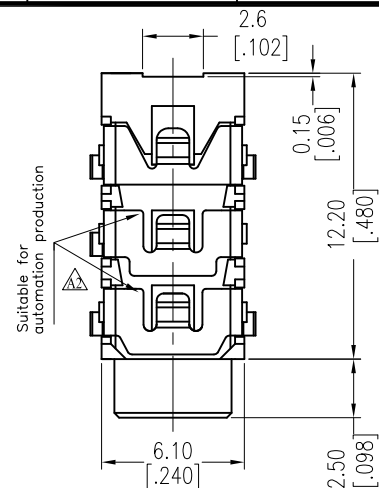
Rated Current:1.0AMP
Contact Resistance:30mΩ max
Withstand Voltage:500V AC/DC
Insulation Resistance:1000MΩ min
Operation Temperature:-40℃ to +105℃

Contact Material:Phosphor Bronze
Contact Plating:Sn Over Ni
Insulator Material:PA6T+30%G.F UL94V-0

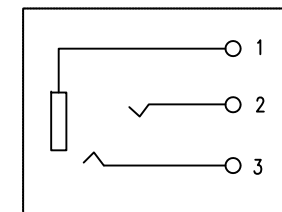
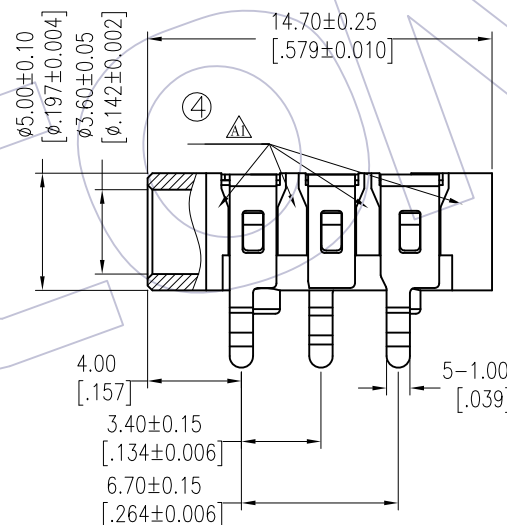
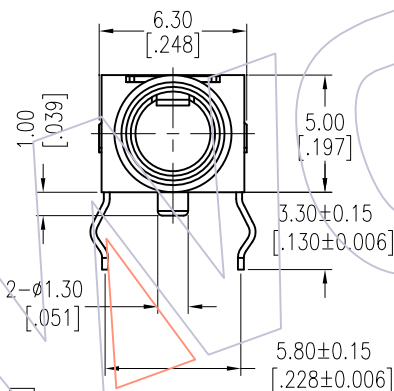
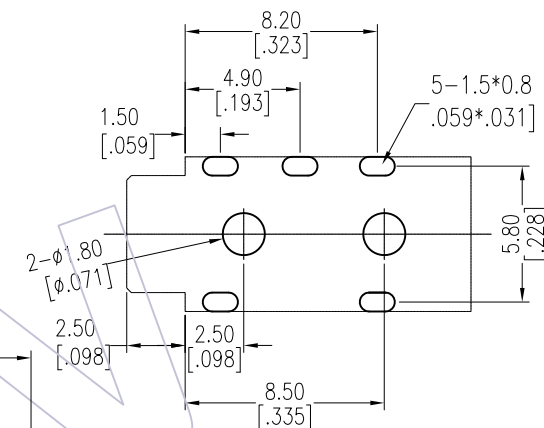
Ordering Information

6620- 3 S C SN B 0 0 1

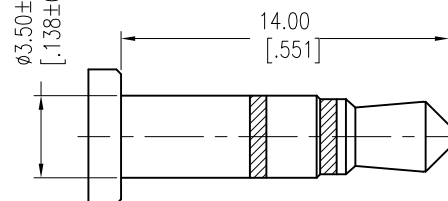
Material C=PA6T
Contact Plating SN=Tin
Colour B=Black
Packing 0=PE Bag
A=Tray
T=Tube



Recommended P.C.B Layout (Top Side)
(PCB BOARD TOLERANCE±0.05)



CIRCUIT DIAGRAM



④	HOUSING	1	PA6T (Black)	----
③	TERMINAL	1	PHOSPHOR BRONZE	SN-Plated
②	TERMINAL	1	PHOSPHOR BRONZE	SN-Plated
①	TERMINAL	1	PHOSPHOR BRONZE	SN-Plated
No.	NAME	QTY	MATERIAL	PLATING

REV	DATE	MODIFICATION DESCRIPTION	CHANGE	OPERATION	DRAW	DATE	SCALE	1:1	PART NO.
A2	2013.07.16	Suitable for automation production	YSH	X.X ±0.40	Atomy	2011.12.20	UNIT	mm	6620-3SCSNB001
A1	2012.12.13	Housing Added Pastern 0.4mm Unilateral	YSH	X.XX ±0.25	CHECK	DATE	SIZE	inch	TITLE:
A0	2012.03.10		-	X.XXX ±0.15			SHEET	1/1	Ø3.5mm PHONE JACK 3P
				Angle ± 3°	APPROVE	DATE	PROJ.	1/1	Customer NO.
				DIM TOL					